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SEMICONDUCTOR M

30V P-Channel PowerTrench[®] MOSFET

General Description

This P-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers, and battery chargers.

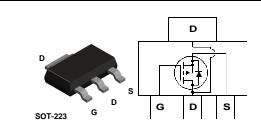
These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable $R_{\text{DS}(\text{ON})}$ specifications.

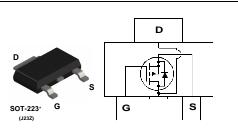
Applications

- Battery chargers
- Motor drives

Features

- 3.4 A, -30 V. $R_{DS(ON)}$ = 130 m Ω @ V_{GS} = 10 V $R_{DS(ON)}$ = 200 m Ω @ V_{GS} = 4.5 V
- · Fast switching speed
- Low gate charge (2.5 nC typical)
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability in a widely used surface mount package





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Sourc	e Voltage		- 30		
V _{GSS}	Gate-Source Voltage			±20		
Ь	Drain Currer	nt – Continuous	(Note 1a)	3.4	A	
	– Pulsed			10		
PD	Maximum Power Dissipation		(Note 1a)	3.0	W	
			(Note 1b)	1.3		
			(Note 1c)	1.1		
T _J , T _{S⊺G}	Operating a	nd Storage Junction T	emperature Range	-55 to +150		
Therma	I Charact	eristics				
R _{0JA}	Thermal Resistance, Junction-to-Ambient (Note 1a)			42	°C/W	
R _{0JC}	Thermal Re	sistance, Junction-to-	Case (Note 1)	12	°C/W	
Packag	e Marking	g and Orderin	g Information			
Device Marking		Device	Reel Size	Tape width	Quantity	
458P		FDT458P	13"	12mm	2500 units	

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					1
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-30			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-23		mV/ºC
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -24 V$, $V_{GS} = 0 V$			-1	μΑ
GSSF	Gate-Body Leakage, Forward	$V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)	·				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.8	-3	V
<u>ΔVgs(th)</u> ΔTj	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			105 157 147	130 200 210	mΩ
D(on)	On–State Drain Current	$V_{GS} = -10 \text{ V}, V_{DS} = -5 \text{ V}$	-5			Α
g fs	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -3.4 A$		3		S
Dvnamic	Characteristics	•		•		
Ciss	Input Capacitance	$V_{DS} = -15 V$, $V_{GS} = 0 V$,		205		pF
Coss	Output Capacitance	f = 1.0 MHz		55		pF
C _{rss}	Reverse Transfer Capacitance			26		pF
Switchin	g Characteristics (Note 2)			•	•	
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -15 V$, $I_D = -1 A$,		4.5	9	ns
tr	Turn–On Rise Time	$V_{GS} = -10 \text{ V}, R_{GEN} = 6 \Omega$		12.5	23	ns
t _{d(off)}	Turn–Off Delay Time			11	20	ns
t _f	Turn–Off Fall Time			2	4	ns
Qg	Total Gate Charge	$V_{DS} = -15 V$, $I_D = -3.4 A$,		2.5	3.5	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = -10 \text{ V}$		0.7		nC
Q _{gd}	Gate-Drain Charge			1		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain–Source			-2.5	Α	
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \ V, \ I_S = -2.5 \ A \ (Note 2)$		-0.8	-1.2	V
	of the junction-to-case and case-to-ambient thermal r $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined		d as the so	lder mounti	ng surface o	f



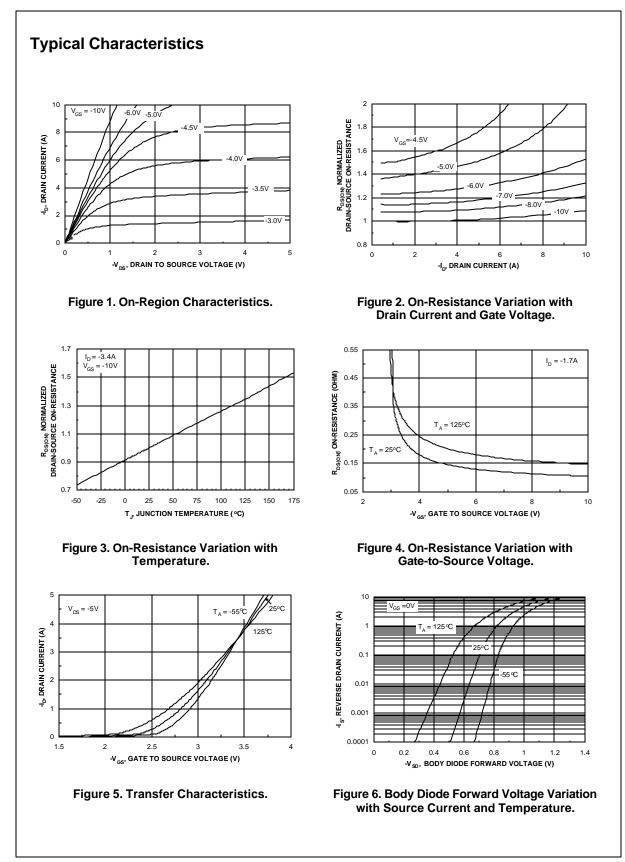
 a) 42°C/W when mounted on a 1in² pad of 2 oz copper

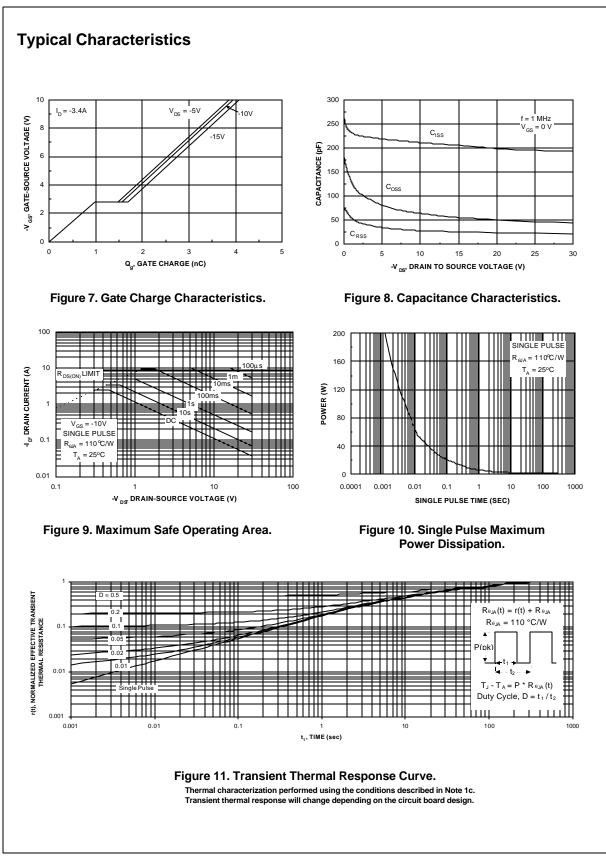
b) 95°C/W when mounted on a .0066 in² pad of 2 oz copper

c) 110°C/W when mounted on a minimum pad.

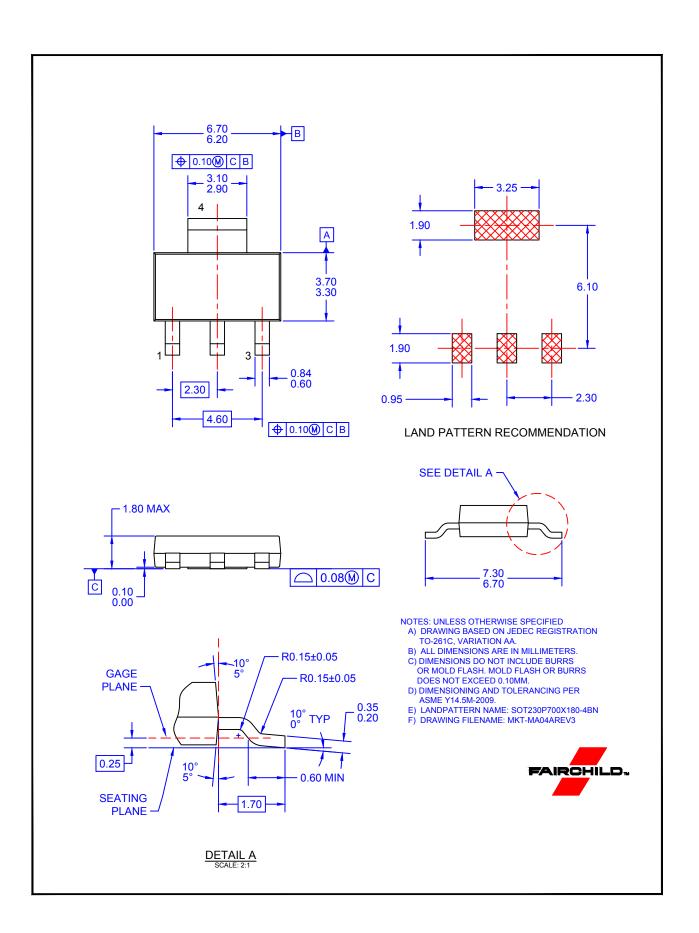
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2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%





FDT458P Rev. B(W)



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